

PMEGxx10EH/EJ series

1 A very low V_F MEGA Schottky barrier rectifiers

Rev. 03 — 11 April 2005

Product data sheet

1. Product profile

1.1 General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifiers.

Table 1: Product overview

Type number	Package		Configuration
	Philips	JEITA	
PMEG2010EH	SOD123F	-	single diode
PMEG3010EH			
PMEG4010EH			
PMEG2010EJ	SOD323F	SC-90	single diode
PMEG3010EJ			
PMEG4010EJ			

1.2 Features

- Forward current: $\leq 1\text{ A}$
- Very low forward voltage

1.3 Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Inverse polarity protection
- Low power consumption applications

1.4 Quick reference data

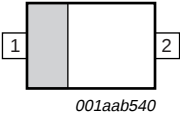
Table 2: Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
I_F	forward current	$T_{sp} \leq 55\text{ }^{\circ}\text{C}$	-	-	1	A
V_R	reverse voltage					
	PMEG2010EH, PMEG2010EJ		-	-	20	V
	PMEG3010EH, PMEG3010EJ		-	-	30	V
	PMEG4010EH, PMEG4010EJ		-	-	40	V
V_F	forward voltage	$I_F = 1000\text{ mA}$ [1]				
	PMEG2010EH, PMEG2010EJ		-	420	500	mV
	PMEG3010EH, PMEG3010EJ		-	450	560	mV
	PMEG4010EH, PMEG4010EJ		-	540	640	mV

[1] Pulse test: $t_p \leq 300\text{ }\mu\text{s}$; $\delta \leq 0.02$.

2. Pinning information

Table 3: Pinning

Pin	Description	Simplified outline	Symbol
1	cathode		 <i>sym001</i>
2	anode		

[1] The marking bar indicates the cathode.

3. Ordering information

Table 4: Ordering information

Type number	Package		
	Name	Description	Version
PMEG2010EH	-	plastic surface mounted package; 2 leads	SOD123F
PMEG3010EH			
PMEG4010EH			
PMEG2010EJ	SC-90	plastic surface mounted package; 2 leads	SOD323F
PMEG3010EJ			
PMEG4010EJ			

4. Marking

Table 5: Marking codes

Type number	Marking code
PMEG2010EH	A9
PMEG3010EH	AA
PMEG4010EH	AB
PMEG2010EJ	AH
PMEG3010EJ	AK
PMEG4010EJ	AL

5. Limiting values

Table 6: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_R	reverse voltage				
	PMEG2010EH, PMEG2010EJ		-	20	V
	PMEG3010EH, PMEG3010EJ		-	30	V
	PMEG4010EH, PMEG4010EJ		-	40	V
I_F	forward current	$T_{sp} \leq 55^\circ\text{C}$	-	1	A
I_{FRM}	repetitive peak forward current	$t_p \leq 1\text{ ms}$; $\delta \leq 0.25$	-	7	A
I_{FSM}	non-repetitive peak forward current	square wave; $t_p = 8\text{ ms}$	-	9	A
P_{tot}	total power dissipation	$T_{amb} \leq 25^\circ\text{C}$			
	SOD123F		[1]	-	375 mW
			[2]	-	830 mW
	SOD323F		[1]	-	350 mW
			[2]	-	830 mW
T_j	junction temperature		-	150	$^\circ\text{C}$
T_{amb}	ambient temperature		-65	+150	$^\circ\text{C}$
T_{stg}	storage temperature		-65	+150	$^\circ\text{C}$

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

6. Thermal characteristics

Table 7: Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]			
	SOD123F		[2]	-	-	330 K/W
			[3]	-	-	150 K/W
			[2]	-	-	350 K/W
	SOD323F		[3]	-	-	150 K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point					
	SOD123F		-	-	60	K/W
	SOD323F		-	-	55	K/W

[1] Schottky barrier rectifier thermal run-away has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses. Nomograms for determining the reverse power losses P_R and $I_{F(AV)}$ rating are available on request.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

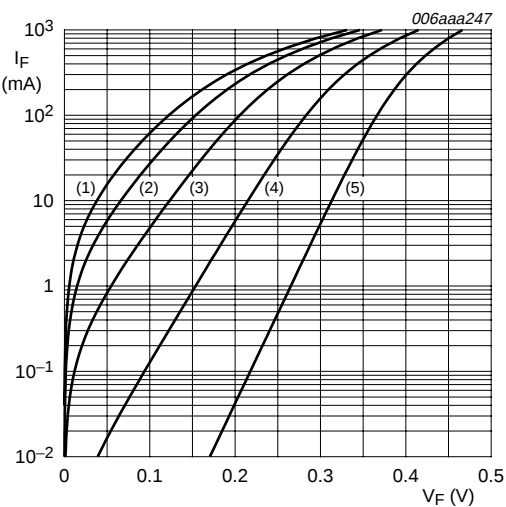
7. Characteristics

Table 8: Characteristics

$T_{amb} = 25^\circ\text{C}$ unless otherwise specified.

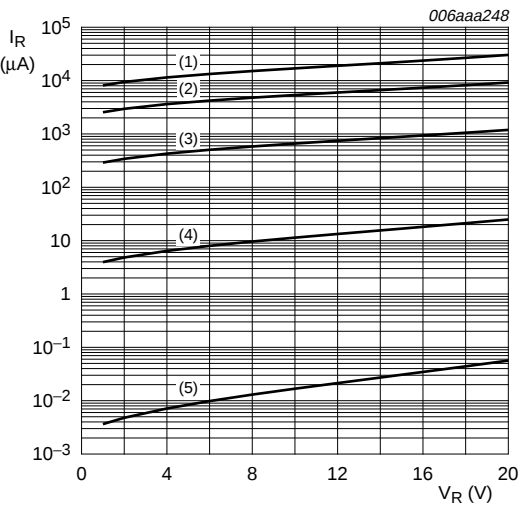
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_F	forward voltage		[1]			
	PMEG2010EH, PMEG2010EJ	$I_F = 0.1\text{ mA}$	-	90	130	mV
		$I_F = 1\text{ mA}$	-	150	190	mV
		$I_F = 10\text{ mA}$	-	210	240	mV
		$I_F = 100\text{ mA}$	-	280	330	mV
		$I_F = 500\text{ mA}$	-	355	390	mV
		$I_F = 1000\text{ mA}$	-	420	500	mV
	PMEG3010EH, PMEG3010EJ	$I_F = 0.1\text{ mA}$	-	90	130	mV
		$I_F = 1\text{ mA}$	-	150	200	mV
		$I_F = 10\text{ mA}$	-	215	250	mV
		$I_F = 100\text{ mA}$	-	285	340	mV
		$I_F = 500\text{ mA}$	-	380	430	mV
		$I_F = 1000\text{ mA}$	-	450	560	mV
	PMEG4010EH, PMEG4010EJ	$I_F = 0.1\text{ mA}$	-	95	130	mV
		$I_F = 1\text{ mA}$	-	155	210	mV
		$I_F = 10\text{ mA}$	-	220	270	mV
		$I_F = 100\text{ mA}$	-	295	350	mV
		$I_F = 500\text{ mA}$	-	420	470	mV
		$I_F = 1000\text{ mA}$	-	540	640	mV
I_R	reverse current					
	PMEG2010EH, PMEG2010EJ	$V_R = 10\text{ V}$	-	15	40	μA
		$V_R = 20\text{ V}$	-	40	200	μA
	PMEG3010EH, PMEG3010EJ	$V_R = 10\text{ V}$	-	12	30	μA
		$V_R = 30\text{ V}$	-	40	150	μA
	PMEG4010EH, PMEG4010EJ	$V_R = 10\text{ V}$	-	7	20	μA
		$V_R = 40\text{ V}$	-	30	100	μA
C_d	diode capacitance		$V_R = 1\text{ V};$ $f = 1\text{ MHz}$			
	PMEG2010EH, PMEG2010EJ		-	66	80	pF
	PMEG3010EH, PMEG3010EJ		-	55	70	pF
	PMEG4010EH, PMEG4010EJ		-	43	50	pF

[1] Pulse test: $t_p \leq 300\text{ }\mu\text{s}$; $\delta \leq 0.02$.



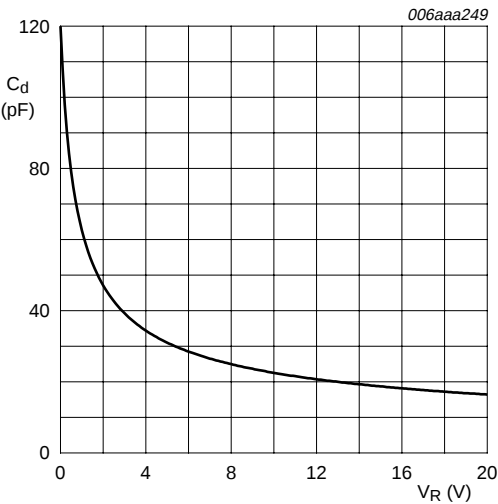
- (1) $T_{amb} = 150\text{ }^{\circ}\text{C}$
- (2) $T_{amb} = 125\text{ }^{\circ}\text{C}$
- (3) $T_{amb} = 85\text{ }^{\circ}\text{C}$
- (4) $T_{amb} = 25\text{ }^{\circ}\text{C}$
- (5) $T_{amb} = -40\text{ }^{\circ}\text{C}$

Fig 1. PMEG2010EH, PMEG2010EJ: Forward current as a function of forward voltage; typical values



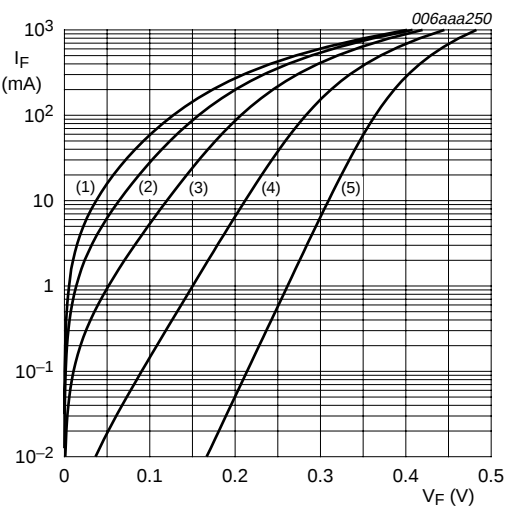
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Fig 2. PMEG2010EH, PMEG2010EJ: Reverse current as a function of reverse voltage; typical values



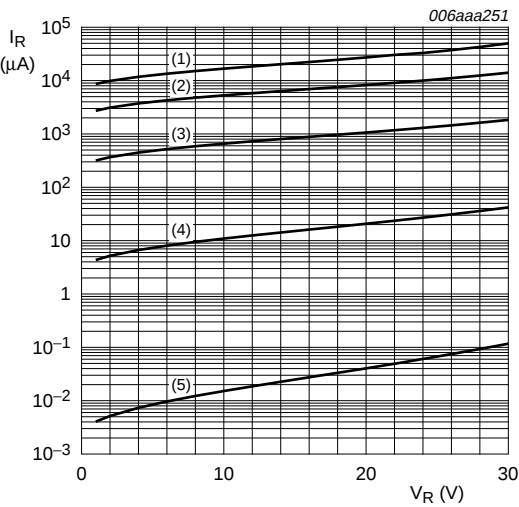
$T_{amb} = 25\text{ }^{\circ}\text{C}$; $f = 1\text{ MHz}$

Fig 3. PMEG2010EH, PMEG2010EJ: Diode capacitance as a function of reverse voltage; typical values



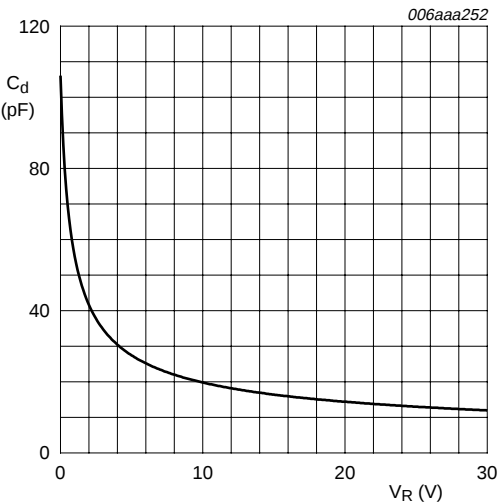
- (1) $T_{amb} = 150\text{ }^{\circ}\text{C}$
- (2) $T_{amb} = 125\text{ }^{\circ}\text{C}$
- (3) $T_{amb} = 85\text{ }^{\circ}\text{C}$
- (4) $T_{amb} = 25\text{ }^{\circ}\text{C}$
- (5) $T_{amb} = -40\text{ }^{\circ}\text{C}$

Fig 4. PMEG3010EH, PMEG3010EJ: Forward current as a function of forward voltage; typical values



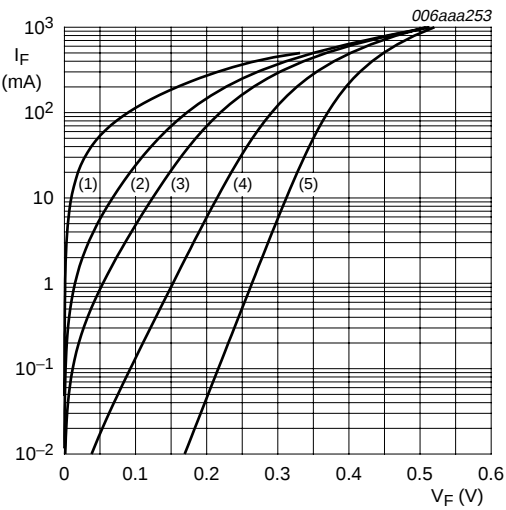
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- (2) $T_{amb} = 125\text{ }^{\circ}\text{C}$
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- (4) $T_{amb} = 25\text{ }^{\circ}\text{C}$
- (5) $T_{amb} = -40\text{ }^{\circ}\text{C}$

Fig 5. PMEG3010EH, PMEG3010EJ: Reverse current as a function of reverse voltage; typical values



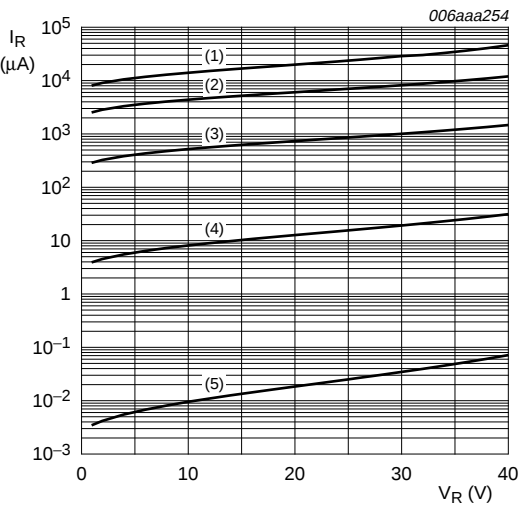
$T_{amb} = 25\text{ }^{\circ}\text{C}$; $f = 1\text{ MHz}$

Fig 6. PMEG3010EH, PMEG3010EJ: Diode capacitance as a function of reverse voltage; typical values



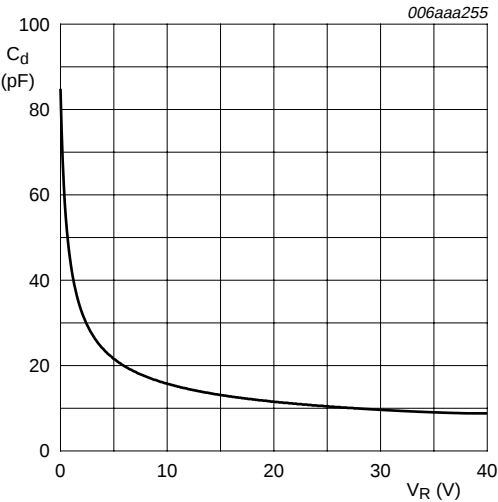
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- (4) $T_{amb} = 25\text{ }^{\circ}\text{C}$
- (5) $T_{amb} = -40\text{ }^{\circ}\text{C}$

Fig 7. PMEG4010EH, PMEG4010EJ: Forward current as a function of forward voltage; typical values



- (1) $T_{amb} = 150\text{ }^{\circ}\text{C}$
- (2) $T_{amb} = 125\text{ }^{\circ}\text{C}$
- (3) $T_{amb} = 85\text{ }^{\circ}\text{C}$
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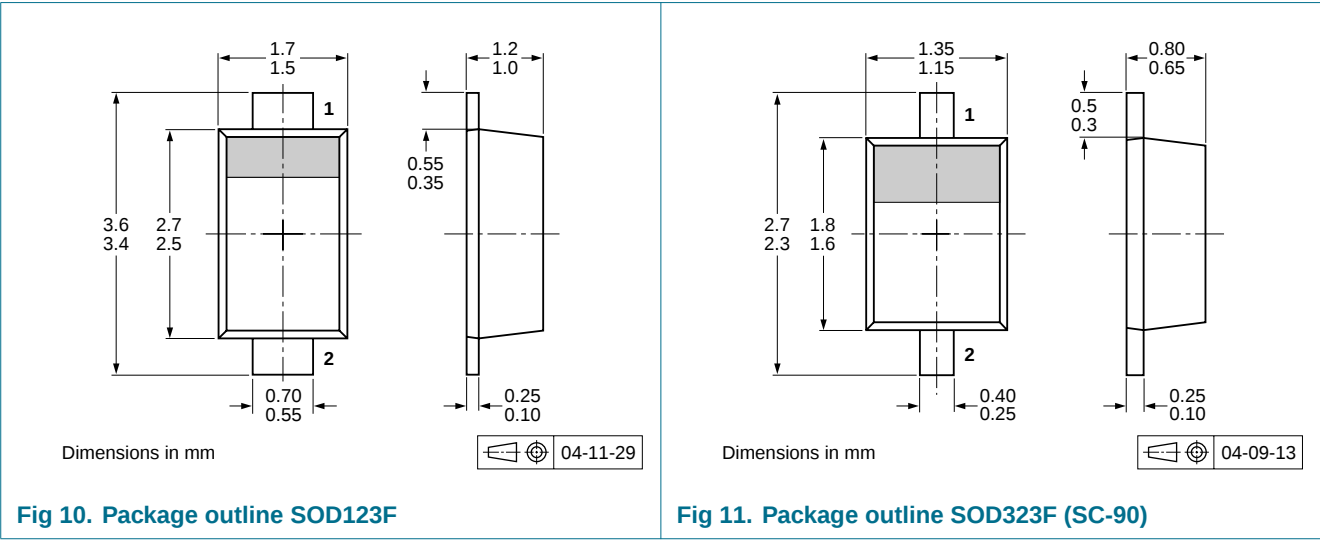
Fig 8. PMEG4010EH, PMEG4010EJ: Reverse current as a function of reverse voltage; typical values



$T_{amb} = 25\text{ }^{\circ}\text{C}$; $f = 1\text{ MHz}$

Fig 9. PMEG4010EH, PMEG4010EJ: Diode capacitance as a function of reverse voltage; typical values

8. Package outline



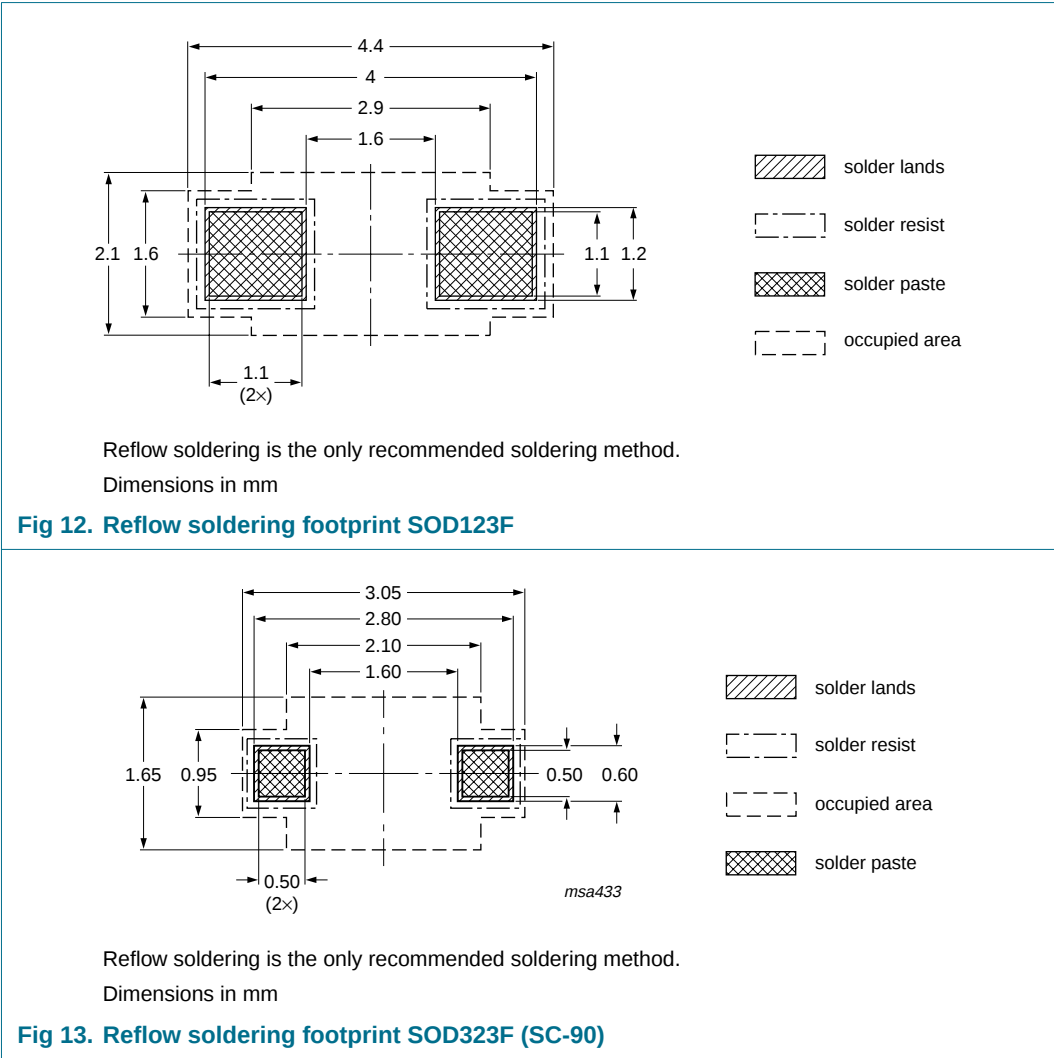
9. Packing information

Table 9: Packing methods
The indicated -xxx are the last three digits of the 12NC ordering code. [1]

Type number	Package	Description	Packing quantity	
			3000	10000
PMEGxx10EH	SOD123F	4 mm pitch, 8 mm tape and reel	-115	-135
PMEGxx10EJ	SOD323F			

[1] For further information and the availability of packing methods, see [Section 15](#).

10. Soldering



11. Revision history

Table 10: Revision history

Document ID	Release date	Data sheet status	Change notice	Doc. number	Supersedes
PMEGXX10EH_EJ_SER_3	20050411	Product data sheet	-	9397 750 14817	PMEGXX10EJ_SER_2
Modifications:	- Types PMEG2010EH, PMEG3010EH, PMEG4010EH added Table 6 P_{tot} values for SOD323F added				
PMEGXX10EJ_SER_2	20050131	Product data sheet	-	9397 750 14228	PMEGXX10EJ_SER_1
PMEGXX10EJ_SER_1	20040907	Objective data sheet	-	9397 750 13596	-

12. Data sheet status

Level	Data sheet status ^[1]	Product status ^{[2] [3]}	Definition
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
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[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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